IN THE UNITED STATES PATENT AND TRADEMARK OFFICE.

Applicant:

Kie Y. Ahn et al.

Examiner: Neal Berezny

Serial No.:

09/484,303

Group Art Unit: 2823

Filed:

January 18, 2000

Docket: 303.648US1

Title:

METHODS FOR MAKING INTEGRATED-CIRCUIT WIRING FROM

COPPER, SILVER, GOLD, AND OTHER METALS

6/26/or

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

missioner for Patents ashington, D.C. 20231

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Supplemental Information Disclosure Statement. However, the Commissioner is hereby authorized to charge the required fees to Account No. 19-0743 in order to have this Supplemental Information Disclosure Statement considered.

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

KIE Y. AHN ET AL.

By their Representatives,

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents, Washington, D.C. 20231, on this day of June, 2002.

Name

Signature